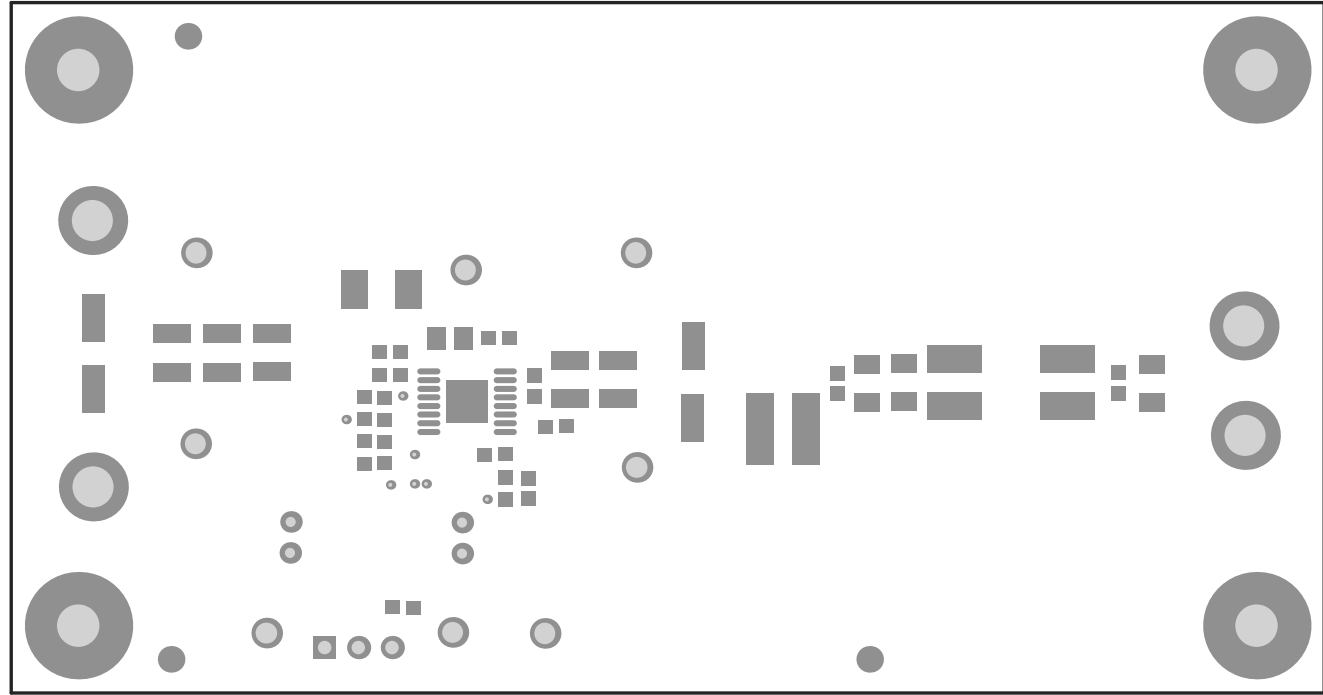


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/13/2015 3:18:57 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP9440

REV: E1

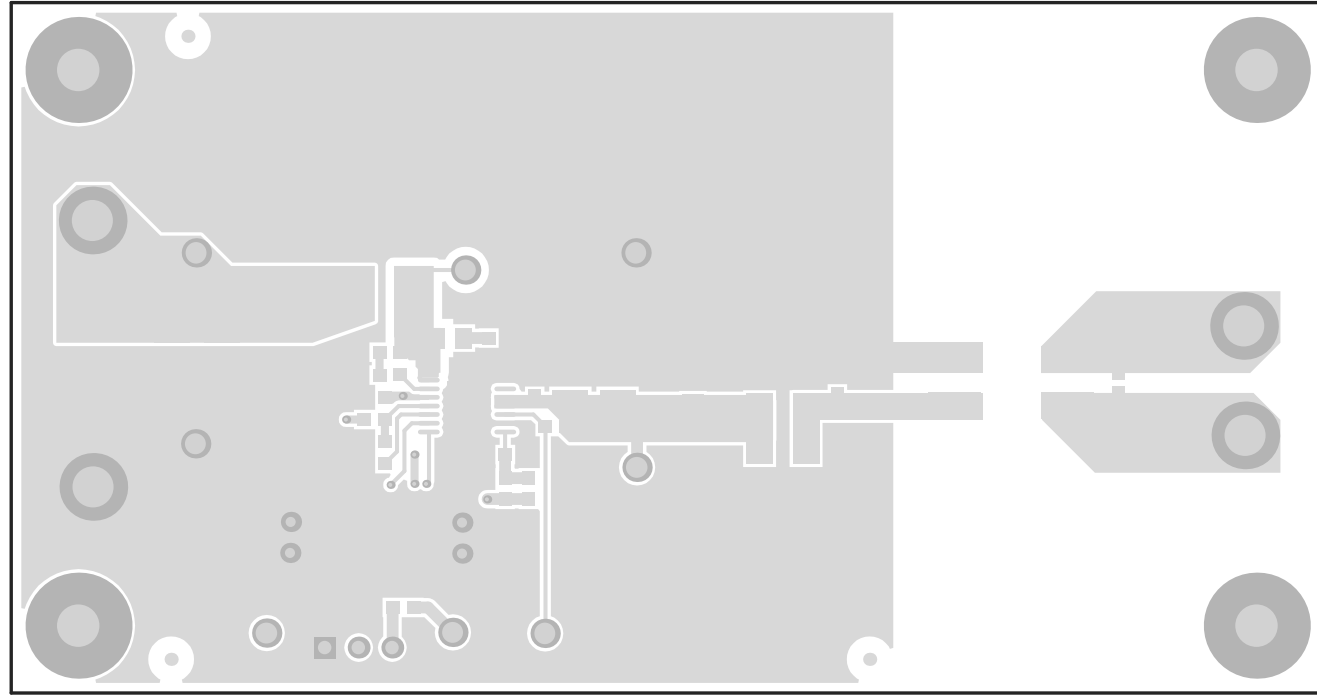
SUN REV: Not In VersionControl

LAYER NAME = Top Solder

PLOT NAME = Top Solder Mask

GENERATED : 10/13/2015 3:18:57 PM

TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP9440

REV: E1

SUN REV: Not In VersionControl

LAYER NAME = Top Layer

PLOT NAME = Top Layer

GENERATED : 10/13/2015 3:18:58 PM

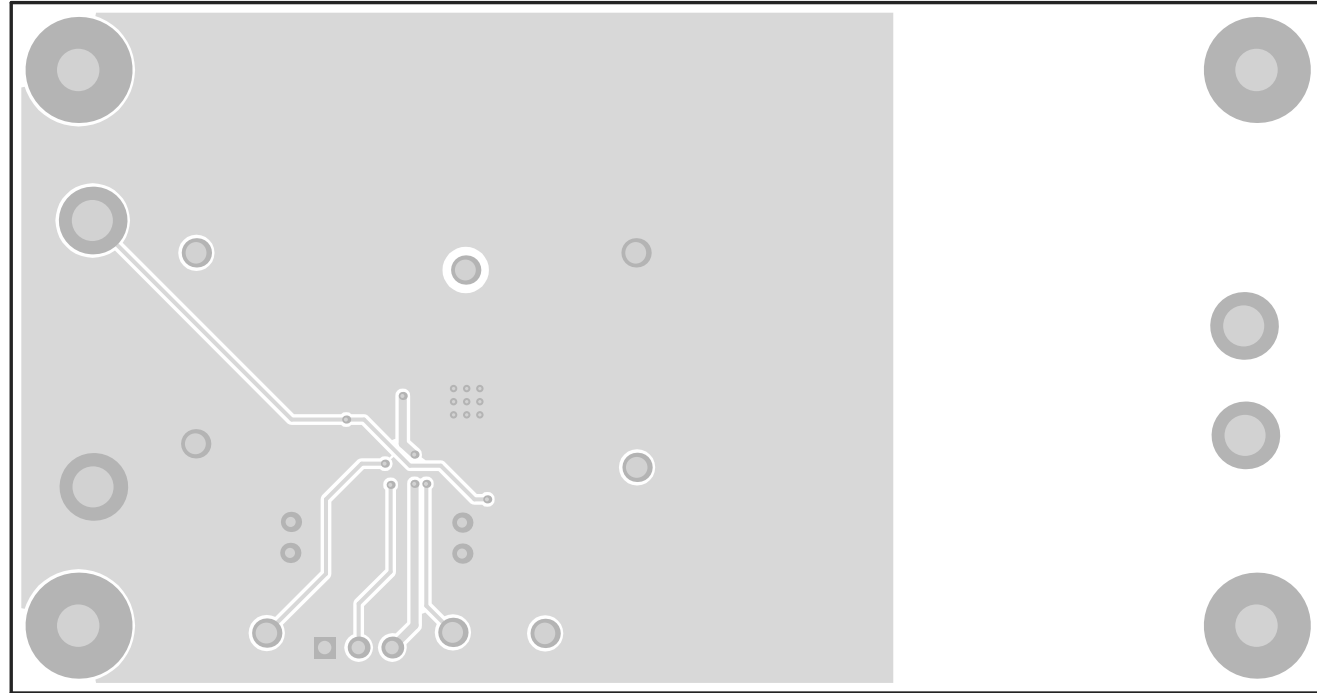
TEXAS INSTRUMENTS



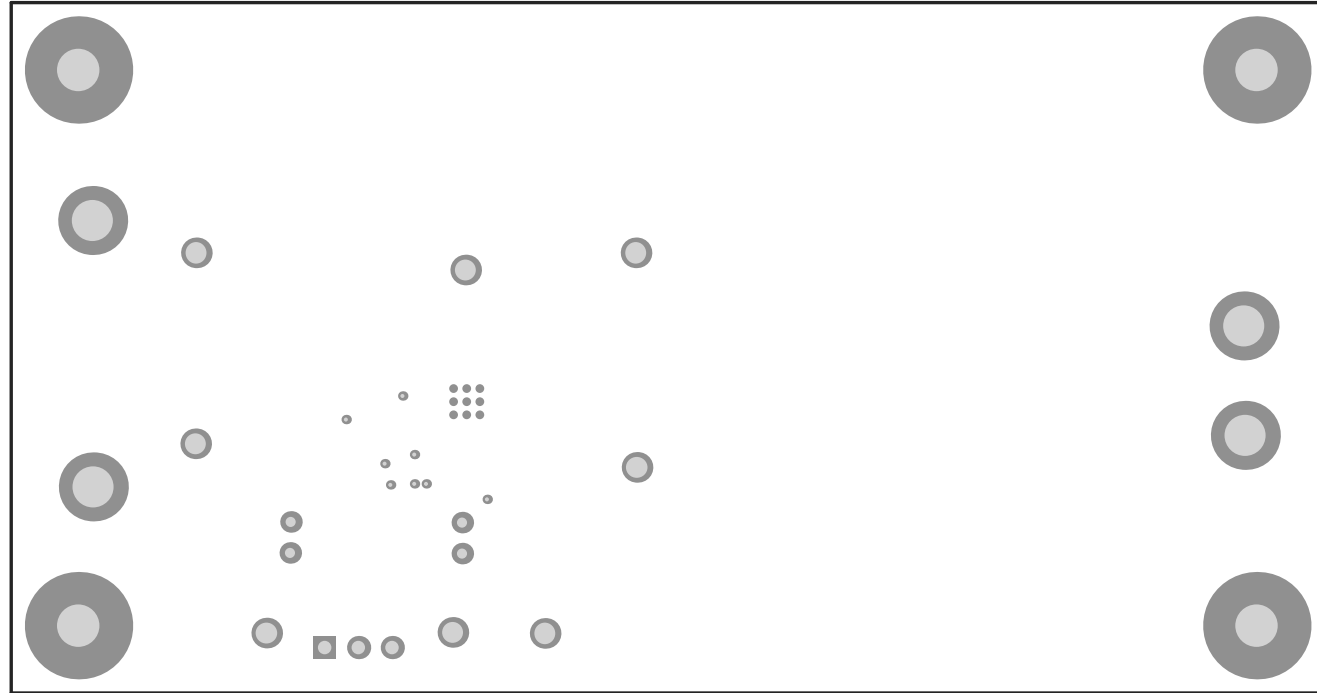
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer1	GENERATED : 10/13/2015 3:18:58 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer2	GENERATED : 10/13/2015 3:18:59 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 10/13/2015 3:18:59 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/13/2015 3:19:00 PM	TEXAS INSTRUMENTS	

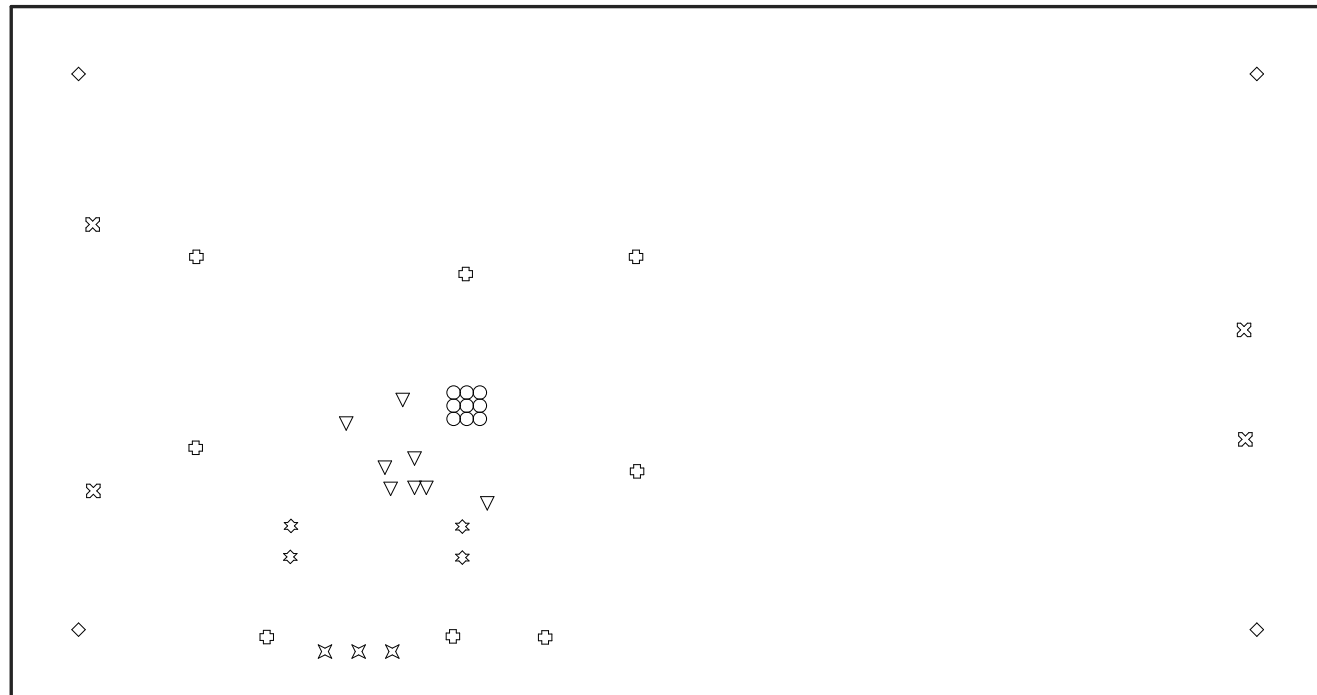
SUN: Not In VersionControl

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UL34V-0 PMP9440.PcbDoc

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/13/2015 3:19:00 PM	TEXAS INSTRUMENTS	

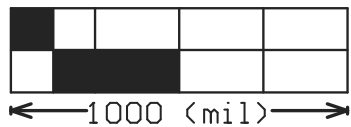




Symbol	Hit Count	Tool Size	Plated	Hole Type
○	9	10mil (0.254mm)	PTH	Round
▽	8	12mil (0.305mm)	PTH	Round
☆	4	30mil (0.762mm)	PTH	Round
✕	3	40mil (1.016mm)	PTH	Round
⊠	8	63mil (1.6mm)	PTH	Round
⊗	4	122.047mil (3.1mm)	PTH	Round
◇	4	125.984mil (3.2mm)	PTH	Round
	40 Total			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 10/13/2015 3:19:01 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9440	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 10/13/2015 3:19:02 PM	TEXAS INSTRUMENTS	

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